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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Hideki SHIMADA, et al.**

Serial No.: **Not Yet Assigned**
(§371 of International Application PCT/JP03/13115)

Filed: **April 5, 2006**

For: **CORROSION-RESISTANT ALUMINUM CONDUCTIVE MATERIAL AND
PROCESS FOR PRODUCING THE SAME**

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Date: April 5, 2006

Sir:

Prior to calculation of the filing fee and examination of this application, please amend the above-identified patent application as follows: